Electronic Patent Application Fee Transmittal							
Application Number:	10049270						
Filing Date:	27-Jun-2002						
Title of Invention:	MULTILAYER PRINTED WIRING BOARD, SOLDER RESIST COMPOSITION, METHOD FOR MANUFACTURING MULTILAYER PRINTED WIRING BOARD, AND SEMICONDUCTOR DEVICE						
First Named Inventor/Applicant Name:	Hul Zhong						
Filer:	Marvin Jay Spivak/Sanja Mahmutovic						
Attorney Docket Number:	312302US40PCT						
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U.S. National Stage under 35 USC 371 Filing	Fees						
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)			
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
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Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)				
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Submission-Information Disclosure Stmt	1806	1	180	180				
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